

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOSII)

## SSM6J08FU

Power Management Switch  
DC-DC Converter

Unit: mm

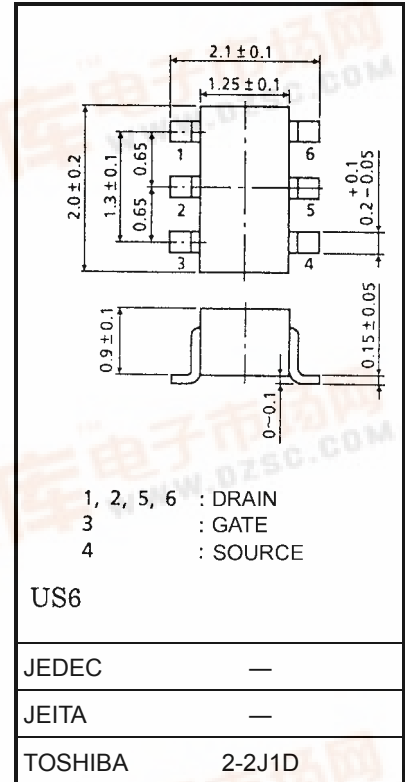
- Small Package
- Low on Resistance :  $R_{on} = 0.18 \Omega$  (max) (@ $V_{GS} = -4 V$ )  
:  $R_{on} = 0.26 \Omega$  (max) (@ $V_{GS} = -2.5 V$ )
- Low Gate Threshold Voltage

Maximum Ratings ( $T_a = 25^\circ C$ )

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		$V_{DS}$	-20	V
Gate-Source voltage		$V_{GSS}$	$\pm 12$	V
Drain current	DC	$I_D$	-1.3	A
	Pulse	$I_{DP}$ (Note 2)	-2.6	
Drain power dissipation		$P_D$ (Note 1)	300	mW
Channel temperature		$T_{ch}$	150	$^\circ C$
Storage temperature range		$T_{stg}$	-55~150	$^\circ C$

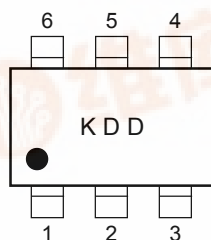
Note1: Mounted on FR4 board  
(25.4 mm  $\times$  25.4 mm  $\times$  1.6 t, Cu Pad:  $0.32 \text{ mm}^2 \times 6$ ) Fig: 1.

Note2: The pulse width limited by max channel temperature.

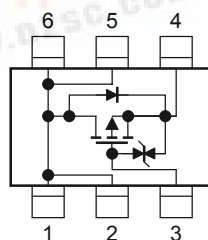
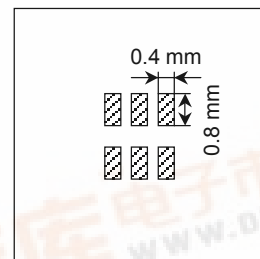


Weight: 6.8 mg (typ.)

## Marking



## Equivalent Circuit

Fig 1: 25.4 mm  $\times$  25.4 mm  $\times$  1.6 t, Cu Pad:  $0.32 \text{ mm}^2 \times 6$ 

## Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

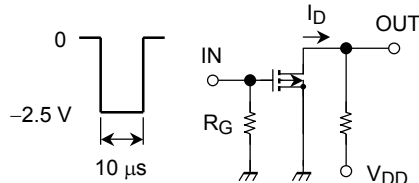
## Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 12\text{ V}, V_{DS} = 0$	—	—	$\pm 1$	$\mu\text{A}$
Drain-Source breakdown voltage	$V_{(BR)DSS}$	$I_D = -1\text{ mA}, V_{GS} = 0$	-20	—	—	V
	$V_{(BR)DSX}$	$I_D = -1\text{ mA}, V_{GS} = 12\text{ V}$	-8	—	—	
Drain Cut-off current	$I_{DSS}$	$V_{DS} = -20\text{ V}, V_{GS} = 0$	—	—	-1	$\mu\text{A}$
Gate threshold voltage	$V_{th}$	$V_{DS} = -3\text{ V}, I_D = -0.1\text{ mA}$	-0.5	—	-1.1	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -3\text{ V}, I_D = -0.65\text{ A}$ (Note 3)	1.3	2.7	—	S
Drain-Source ON resistance	$R_{DS(ON)}$	$I_D = -0.65\text{ A}, V_{GS} = -4\text{ V}$ (Note 3)	—	140	180	m $\Omega$
		$I_D = -0.65\text{ A}, V_{GS} = -2.5\text{ V}$ (Note 3)	—	200	260	
		$I_D = -0.65\text{ A}, V_{GS} = -2.0\text{ V}$ (Note 3)	—	260	460	
Input capacitance	$C_{iss}$	$V_{DS} = -10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	370	—	pF
Reverse transfer capacitance	$C_{rss}$	$V_{DS} = -10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	73	—	pF
Output capacitance	$C_{oss}$	$V_{DS} = -10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	116	—	pF
Switching time	Turn-on time	$t_{on}$	$V_{DD} = -10\text{ V}, I_D = -0.65\text{ A},$	—	33	ns
	Turn-off time	$t_{off}$	$V_{GS} = 0 \sim -2.5\text{ V}, R_G = 4.7\text{ }\Omega$	—	47	ns

Note 3: Pulse test

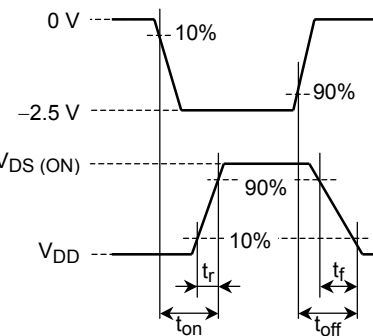
## Switching Time Test Circuit

### (a) Test circuit

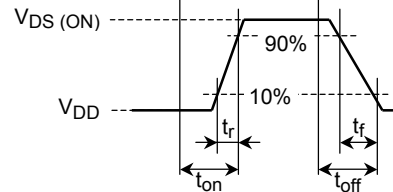


$V_{DD} = -10\text{ V}$   
 $R_G = 4.7\text{ }\Omega$   
 $D.U. \leq 1\%$   
 $V_{IN}: t_r, t_f < 5\text{ ns}$   
 COMMON SOURCE  
 $T_a = 25^\circ\text{C}$

### (b) $V_{IN}$



### (c) $V_{OUT}$



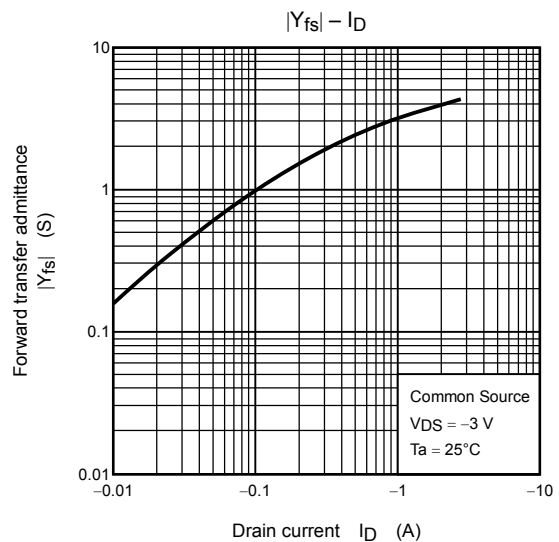
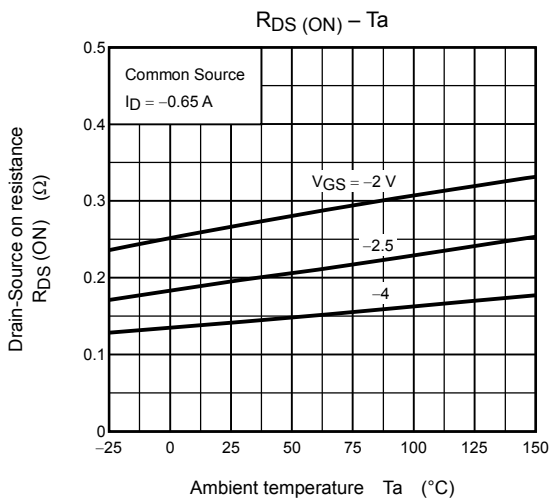
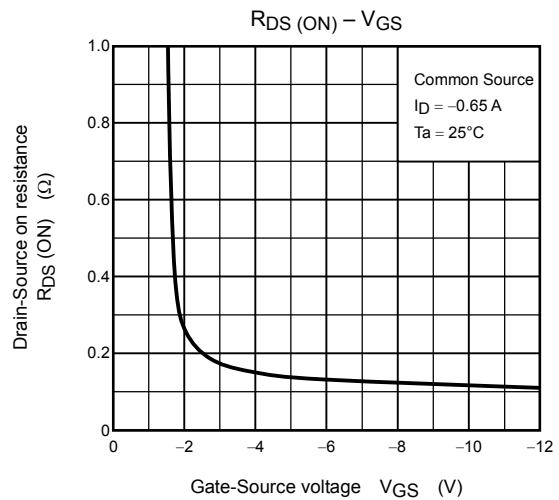
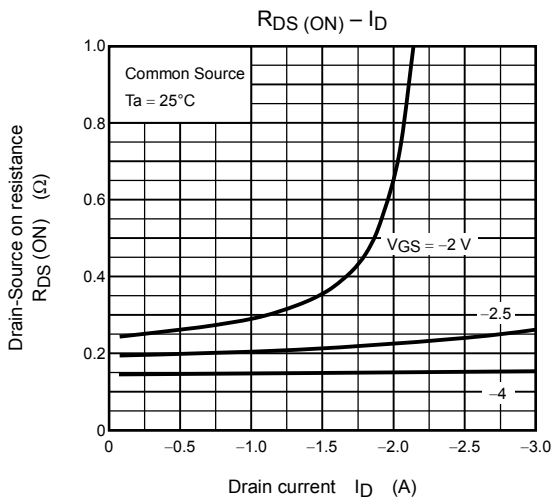
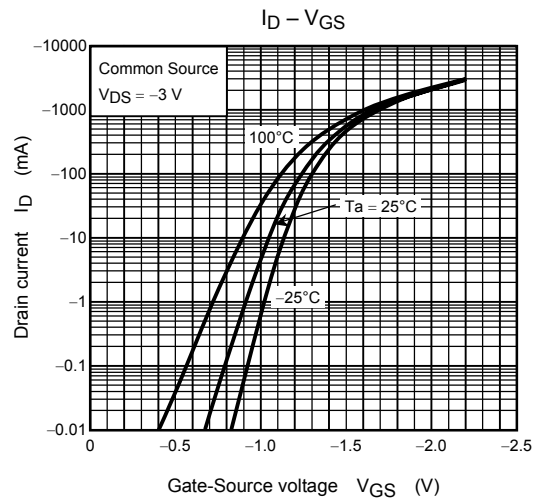
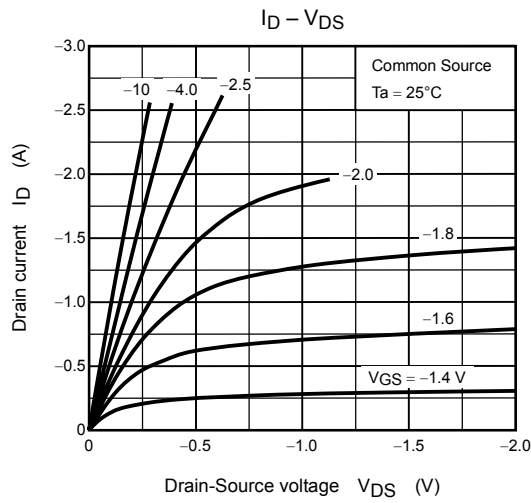
## Precaution

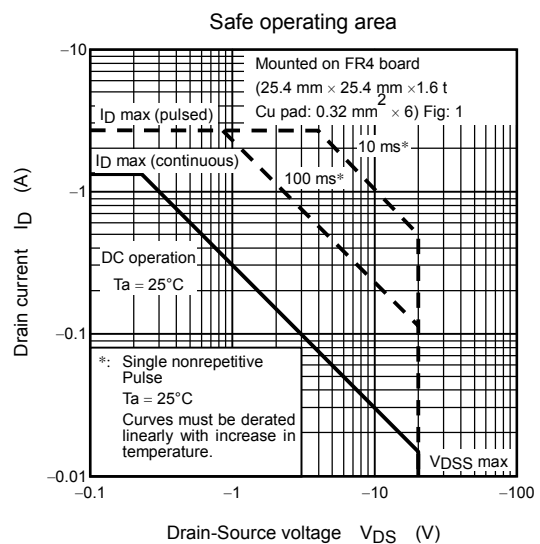
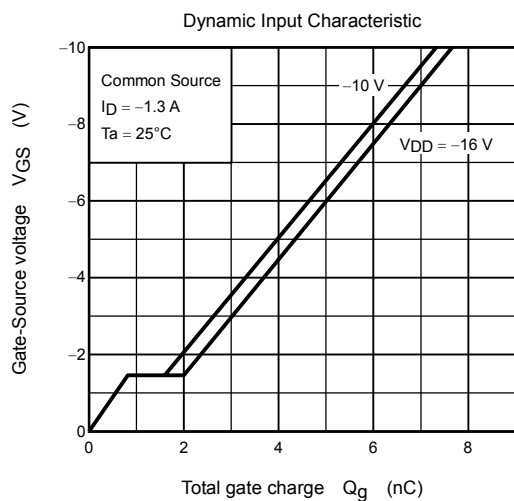
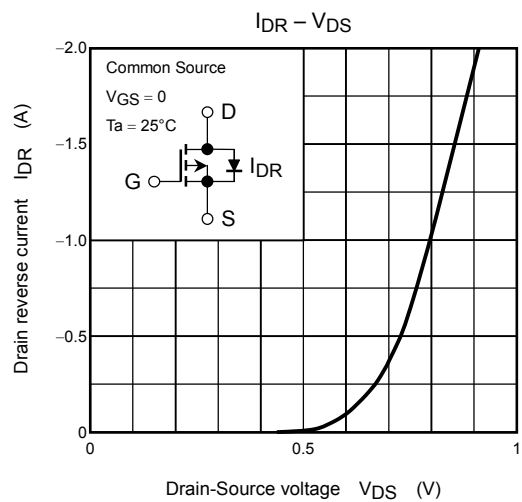
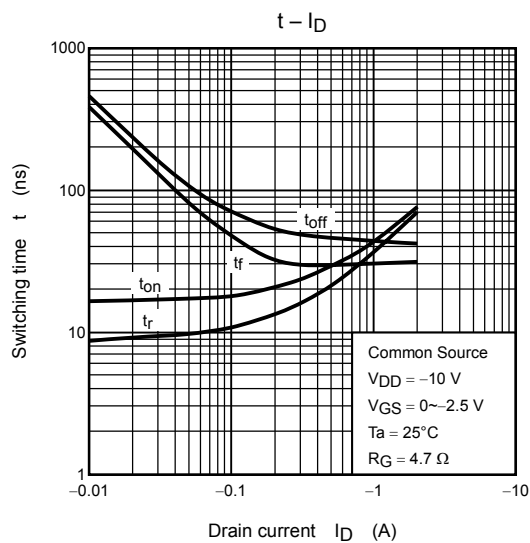
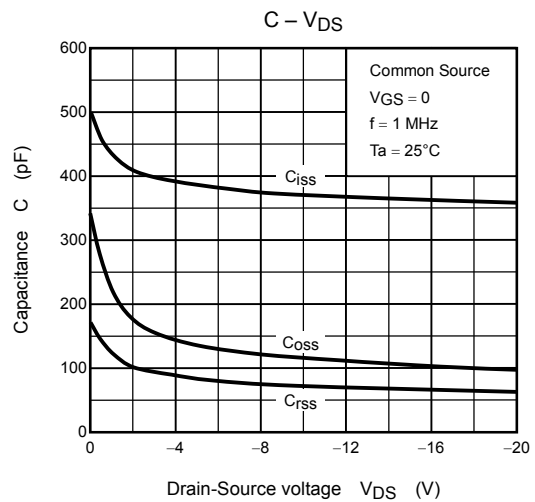
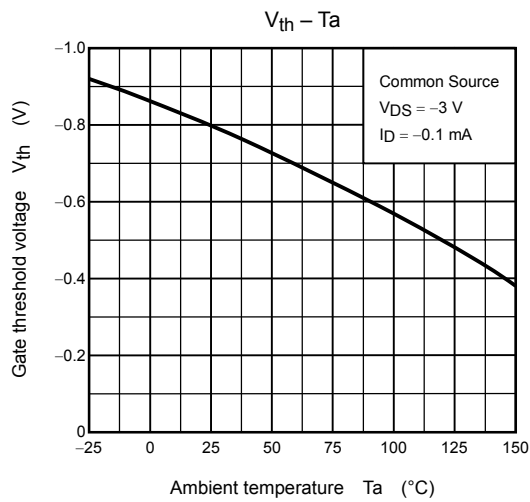
$V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D = -100\text{ }\mu\text{A}$  for this product. For normal switching operation,  $V_{GS(on)}$  requires higher voltage than  $V_{th}$  and  $V_{GS(off)}$  requires lower voltage than  $V_{th}$ .

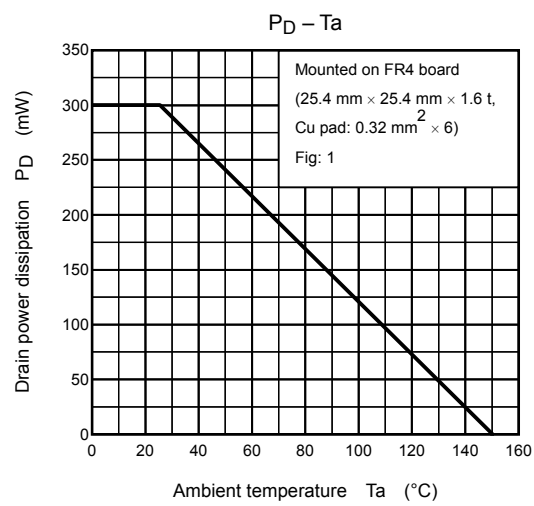
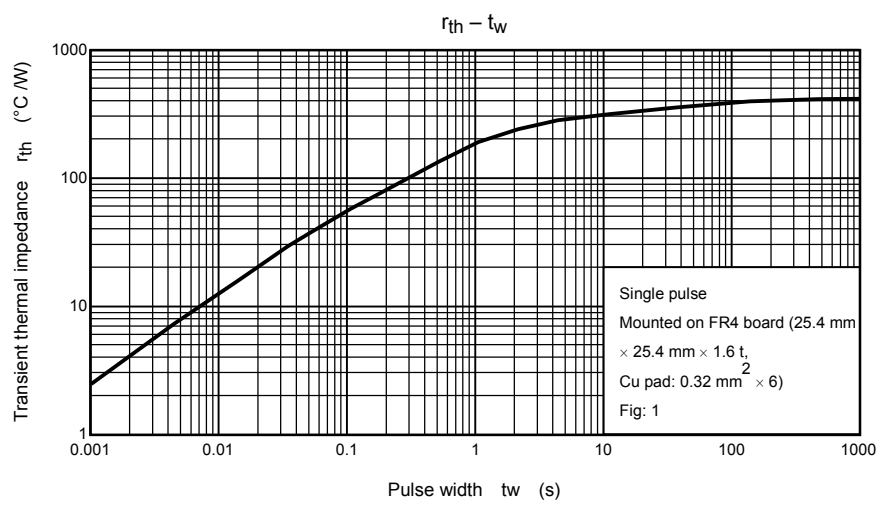
(relationship can be established as follows:  $V_{GS(off)} < V_{th} < V_{GS(on)}$ )

Please take this into consideration for using the device.

$V_{GS}$  recommended voltage of  $-2.5\text{ V}$  or higher to turn on this product.







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